



标准&定制开关连接器产品制造商  
DONG GUAN XI BANG ELECTRONICS CO., LTD.

## 规 格 书

### SPECIFICATION

CUSTOMER NAME 客户名称: \_\_\_\_\_

CUSTOMER NO. 客户编号: \_\_\_\_\_

SERIES 系列: 轻触开关

MODEL NO. 型号: XB-TS4059M series

DRAWING NO. 图形号: SMD Tact Switch

If specification of this product meets your request, please confirm all the items of it and return to us with signature and stamp, it will be basis of our production and record. Thanks your cooperation in advance!

若此产品规格符合贵司要求，敬请确认此规格书内所有项目

并签名和盖章后回传给我司，以作我司产品制作之

依据和存档之用，多谢合作！

#### EXAMINE & APPROVAL 审批

APPROVE 接受	NOT APPROVE 不接受

PREPARED BY. 制表人	CHECKED BY. 校对	APPROVED BY. 审核	APPROVAL BY. 批准
研发部 戴海明 2022. 06. 08	品质部 黄自清 2022. 06. 08	工程部 庞军 2022. 06. 08	总经办 吴量 2022. 06. 08

东莞市溪榜电子有限公司

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Dong Guan XB Electronics Co., Ltd

Account Number : 705540238

Bank Name : Citibank N. A., Hong Kong Branch

Country/Region: Hong Kong

Bank Code: 006

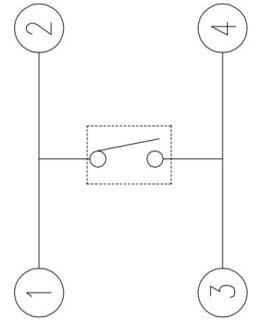
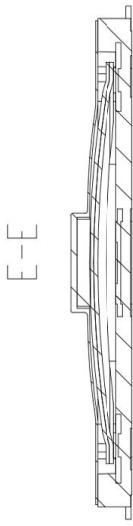
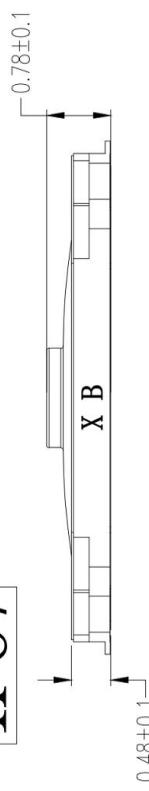
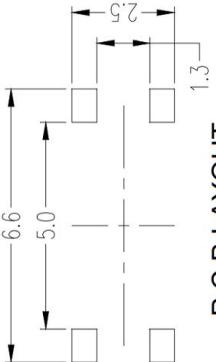
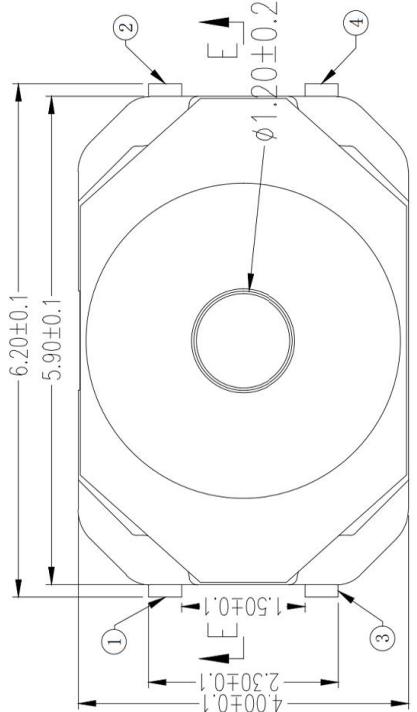
Bank Address: 3 Garden Road, Central, Hong Kong

SWIFT/BIC : CITIHKHX (CITIHKHXXXX\* If 11 characters are required)

MAIL : HK@ALPSR.COM XB@ALPSR.COM XB@ALPSR.COM

Quality core! Afterburner for Made in China!

## IP67



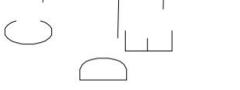
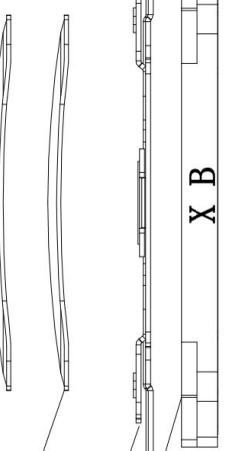
### P.C.B LAYOUT

### CIRCUIT DIAGRAM

### SPECIFICATIONS

Rating	DC 12V 50mA Max.		
Contact Resistance	50mΩ Max.	A	2012-9-25
Travel	0.30 ± 0.10 mm	ISSUE DATE	初版
Operating Force	2   180 ± 50gf	3   230 ± 50gf	DESCRIPTIONS OF REVISION
Operating Life (cycles)	100,000		X-B-TS4059M

序号	名称	数量	材料	备注
A	点	1	PA	黑色
B	白膜	1	PA	白色
C	弹片	2	SUS301-SEI	单面Ag0.5
D	接线片	1	G5210	双面Ag0.5
E	基座	1	P9T	黑色



8	TOLERANCE		
7	UNLESS SPECIFIED		
6	WITHIN 1.5mm : ±0.1mm	A	2012-9-25
5	OVER 1.5mm : ±0.2mm	ISSUE DATE	APPD.
4	TITLE : Tact Switch	UNIT : mm	DRWG No.: XB-TS4059M
3	MODEL: XB-TS4059M	SCALE: 5:1	ZENQ. CHEN APPD.
2	CASE SUS PPA/BRASS SRTIP STEEL STRIP	5:1	2012-9-25
1	COVER 1 NI PLATED	DWN.	JUN. YANG
NO.	KNOB PPA	1 BLACK	CHKD DONG. PANG
	PARTS MATERIALS Q'TY	FINISH	ZENQ. CHEN APPD.
			2012-9-25



东莞市溪榜电子有限公司  
DONG GUAN XI BANG ELECTRONIC CO., LTD.  
Switch Connector

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### 1. General(一般事项):

1.1 Operating Temperature Range (使用之温度范围):-40°C ~ +85°C

1.2 Storage Temperature Range(储存之温度范围): -40°C ~ +85°C

### 1.3 Test conditions(测试状态)

Unless otherwise specified, the test and measurements shall be carried out as follows.

除非另有说明，测试与测量应如下条件进行。

Ambient temperature(环境温度) : 5~35 °C

Relative humidity(相对溼度) : 45~85 %

Air pressure(气压) : 86~106 kPa

However, if doubt arises on the decision based on the measured values under the above-mentioned conditions, the following conditions shall be employed.

无论如何，如果上述条件量测时有疑虑时，应在下列条件使用

Ambient temperature(环境温度) : 20± 2°C

Relative humidity(相对溼度) : 65±5 %

Air pressure(气压) : 86~106 kPa

### 2. Rating(额定负载):

10uA, 2V DC (MIN.) / 20mA, 15V DC (MAX.)

### 3. Type of Actuation: Tactile feedback.(类型：触动回复式)

### 4. Test Sequence(测试项目) :

二、

特性	项次	测试种类	测试条件	测试要求
外观 <b>Appearance</b>	1	Visual Examination 目视检查	By visual examination check without any out pressure & testing. 在未施加任何外力及试验前,以目视方式检测	By visual examination check without any out pressure & testing. 在未施加任何外力及试验前,以目视方式检测
电气特性 <b>Electrical Performance</b>	2	Contact Resistance 接触阻抗	Applying a static load 1.5-2 times the operating force to the center of the stem, measurements shall be made with a 1 kHz small current contact resistance meter 用一作动力 1.5-2 倍力量的静态荷重,实际按压触钮 的中央处,并 1KHZ 规格的微电流阻抗计测量接触阻抗值	500mΩ Max. (initial)
	3	Insulation Resistance 绝缘阻抗	100V DC, 1 minute ± 5 sec. 直流电压 100V, 1 分钟±5 秒	50MΩ Min.



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电气特性 Electrical Performance	4	withstand Voltage 耐电压	<p>250V AC (50Hz or 60 Hz 2mA) shall be applied between all the adjacent terminals and between the terminal and the frame for 1 minute. 以 250V 的交流电 50HZ 或 60HZ 2MA, 施于两相邻端子与底座间, 并保持 1 分钟之加压状态后, 检查是否能耐该值</p>	No dielectric breakdown shall be occurred 成品不得有故障, 跳火及绝缘体破坏等不良现象
机械特性 Mechanical Performance	5	Bounce 弹跳	<p>3 to 4 operations at a rate of 1 cycles per second 每秒 3~4 次的速度为一循环, 观察示波器上之显示</p>	<p>10 m seconds Max. 不得高于 10 毫秒</p>
	6	Operation Force 作动力	<p>Applied in the direction of operation. 测定触钮操作方向之力量</p>	160±50gf
	7	Stroke 作动量	<p>Placing the switch such that the direction of switch operation is vertical and then gradually increasing the load applied to the center of the stem to a stop shall be measured 将成品放置定位后, 以一垂直力慢慢施压在按钮的中央处, 使按钮从开始按压到无法按压停止, 测量实际按压过程的距离</p>	0.13±0.10mm
	8	Click	<p>Click=(OF-OD)/OF×100%</p>	<p>30% MIN. (before reflow soldering)</p>
	9	Control strength 操作部强度	<p>The static load of 5kg shall be applied in the operating direction of the control unit for 15 seconds. 以 5KG 的静态荷重施于推钮上方, 操作时间 15 秒</p>	<p>As shown in item 2~6 受测后之成品仍需合述 4~7 测试 项规格之要求</p>



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<b>机械特性 Mechanical Performance</b>	10	Solder Heat Resistance 抗錫热	SMT Type ~T1C Series(5/7)	1) Shall be free from pronounced backlash and falling-off or breakage terminals  2) As shown in item 2~5 1) 浸錫后, 端子不得有明显的焦黑镀层剥落或断裂现象 2) 受测后的成品仍需符合前述 2~5 测试项规格的要求	1)As shown in item 4、5 2)Operating force: $\pm 30\%$ of initial force 3)Contact Resistance: 20Ω Max. 4)Insulation Resistance: 10MΩ Min. 5)Bounce: 30 m seconds Max.  1) 受测后的成品仍需符合 4、5 测试项规格的要求 2) 测试后, 作动力之变化需为初始值土 30% 3) 测试后的接触阻抗值不得高于 20 Ω 4) 受测后的绝缘阻抗值不得低 10M Ω 5) 受测后的回弹反应时间须于 30 秒内
<b>耐久性 Durability</b>	11	Life Test 寿命测试	Measurements shall be made following the test forth below: 1) 20mA, 15 V DC resistive load 2) Rate of Operation: 2~3 operation per second 3) Applying a static load the operating force to the center of the stem in the direction of operation 4) Cycle of Operation: 300,000 次 测试时需按照下列所设定之情况: 1) 施以 5MA, 5VDC 之直流电 2) 测定速度: 2~3 次 / 秒 3) 测定时需于开关操作方向以 OF 限之静态荷重施于按钮中央处 4) 受测次数: 300,000 次		
<b>耐候性 Environmental Endurance</b>	12	Vibration 振动测试	Shall be vibrated in accordance with Method 201A of MIL-STD-202F 1) Swing distance=1.5mm 2) Frequency: 10-55-10 Hz 1 minute/cycle. 3) Direction: 3 vertical directions including the direction of operation. 4) Test Time: 2 hours each direction. 请依照 MIL-STD-202F,201A 所规定之方法做测试 1) 振幅=1.5mm 2) 频率: 10-55-10HZ 的频率循环测试, 周期 1 分钟 3) 振动方向: 以 X,Y,Z 三轴向, 包含推钮操作之方向 4) 测试时间: 每一方向 2 小时	As shown in item 2~6 受测后之成品仍需符合前述 2~6 测试项规格的要求	



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耐候性 Environment al Endurance	13	Cold Resistance 耐寒性	<p>Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made :</p> <p>1) Temperature : -40°C±2°C. 2) Time: 500 hours.</p> <p>请依照下列所设定的条件测试后,并于常温常湿中放置 1 小时后测定</p> <p>1) 受测温度:-40±2°C 2) 受测时间:500 小时</p>	As shown in item 2~6 受测后之成品仍需合述 2-6 测试项规格之要求	
	14	Heat Resistance 耐热性	<p>Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made :</p> <p>1)Temperature : 85°C±2°C 2)Time: 500 hours</p> <p>请依照下列所设定的条件测试后,并于常温常湿中放置 1 小时后测定</p> <p>1) 受测温度:85±2°C 2) 受测时间:500 小时</p>	Ditto 同上	
	15	Humidity Resistance 耐湿性	<p>Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made :</p> <p>1)Temperature : 60°C±2°C 2)Relative Humidity : 90~95% 3)Time: 500 hour</p> <p>请依照下列所设定的条件测试后,于常温常湿中放置 1 小时后测定</p> <p>1) 受测温度:60±2°C 2) 相对湿度:90~95% 3) 受测时间:500 小时</p>	1)Contact Resistance: 1Ω Max 2)Insulation Resistance: 10MΩ Min 3)As shown in item 4~6 1) 测试后的接触阻抗值不得高于 1 Ω 2) 受测后的绝缘阻抗值不得低于 10MΩ 3) 受测后的成品仍需符合 4-6 测试项规格的要求	



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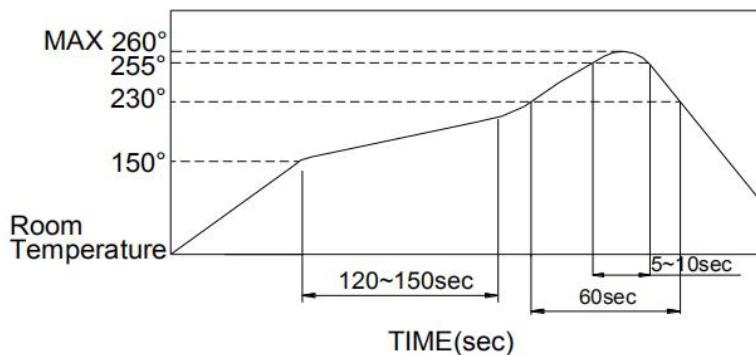
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耐候性 <b>Environmental Endurance</b>	16	Change of temperature 温度循环	After 5 cycles of following conditions, the switch shall be allowed to stand under normal room temperature and humidity conditions for 1 hr, and measurement shall be made within, 1 hr after that. Water drops shall be removed. 1) 测试周期: 20 个循环 2) 标准条件试验后: 1 小时 3) 1 个循环: 	As shown in item 2~6 受测后之成品仍需合述 2-6 测试项规格之要求

## 六、Soldering Conditions(焊锡条件):

\*SMT 系列



- The condition mentioned above is the temperature on the Cu foil of the P.C.B surface. There are cases where board's temperature greatly differs from switch's surface temperature depending on board's material, size, thickness, etc. Care, therefore, should be used not to allow switch's surface temperature to exceed 260°C

上述提到的情况,是 PCB 上铜箔之温度。有一些情形是这 PCB 的温度和开关表面之温度会有很大的不同,这和 PCB 材质.大小.厚度等有很大的关系,因此要小心不要让开关表面的温度超过 260°C



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## Manual Soldering(手工焊锡)

Soldering Temperature(焊锡温度)	Soldering Temperature(焊锡温度)
Max.350°C	Max.350°C

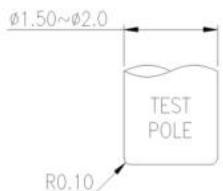
## ■ Precautions in Handling(处理时注意事项):

1. Care should be exercised so that flux from the upper part of the printed circuit board does not adhere to the switch.

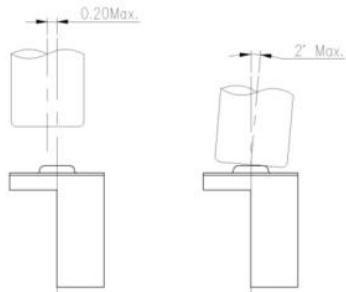
在 P. C. B 板面上之助鋅剂，不要黏到开关本身

2. Prohibited items and notes on mounting and operating conditions(使用开关须注意事项):

### 2.1 Recommended shape of test pole(建议之测头形状大小)



### 3.2 Recommended operating conditions(建议之操作条件)





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**■Notes on storage conditions(储存条件的注意事项):**

Do not store in the following environment or it may affect product's function and solderability:

当物品被储存于以下的情形与条件它可能会影响产品功能变差及吃锡性等..

应避免储存于下列情形

1.temperature of -10 (max)、 +40 (min) °C & humidity at 85% (min)

摄氏温度低于-10 °C或高于 40°C，且湿度高于 85%之环境

2.environment with corrosive gas

空气中含有腐蚀性气体

3.storage over 6 months

长期储存超过六个月

4.place of direct sunlight

阳光直接照射的地方

\*Store with proper packaging conditions and to avoid loading heavy force.

储存时保持包装完整，以免外应力施加于产品

\*We suggest to use the products within 3 months or at least 6 months.

收到产品后请尽快使用，建议三个月内使用完毕，若须存放请勿超过六个月

\*After opening the package, the rest products must be stored in the appropriate moisture-proof & airtight environment

剩余产品若已开封，请将产品储存于防潮、密闭的环境中